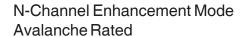


Linear[™] Power MOSFET w/ Extended FBSOA

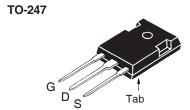
IXTH12N100L

 $V_{DSS} = 1000V$ $V_{D25} = 12A$ $V_{D25} \leq 1.3\Omega$





Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	$T_J = 25^{\circ}C$ to $150^{\circ}C$	1000	V	
V _{DGR}	$T_{_{\rm J}} = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}, R_{_{\rm GS}} = 1\text{M}\Omega$	1000	V	
V _{GSS}	Continuous	±30	V	
V _{GSM}	Transient	±40	V	
I _{D25}	T _C =25°C	12	A	
I _{DM}	$T_{c} = 25^{\circ}C$, Pulse Width Limited by T_{JM}	25	Α	
I _A	$T_{c} = 25^{\circ}C$	12	Α	
E _{AS}	$T_{c} = 25^{\circ}C$	1.5	J	
P _D	T _c =25°C	400	W	
T		-55+150	°C	
T_{JM}		150	°C	
T _{stg}		-55+150	°C	
T _L	1.6mm (0.063 in.) from Case for 10s	300	°C	
T _{SOLD}	Plastic Body for 10s	260	°C	
M _d	Mounting Torque	1.13/10	Nm/lb.in.	
Weight		6	g	



G = Gate	D	= Drain
S = Source	Tab	= Drain

Features

- International Standard Package
- Designed for Linear Operation
- Avalanche Rated
- Molding Epoxy Meets UL94 V-0 Flammability Classification

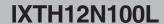
Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- Programmable Loads
- Current Regulators
- DC-DC Converters
- Battery Chargers
- DC Choppers
- Temperature and Lighting Controls

SymbolTest ConditionsCharacteristics $(T_J = 25^{\circ}C, Unless Otherwise Specified)$ Min.		cteristic Typ.	istic Values p. Max.		
BV _{DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	1000			V
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	3.5		5.5	V
I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$				μΑ
	T _J = 125°C			500	μΑ
R _{DS(on)}	$V_{GS} = 20V, I_{D} = 0.5 \bullet I_{DSS}, \text{ Note 1}$			1.3	Ω





SymbolTest ConditionsCharacteristic $(T_J = 25^{\circ}C, Unless Otherwise Specified)$ Min. Typ.		Values Max.		
g _{fs}	V _{DS} = 20V, I _D = 0.5 • I _{DSS} , Note 1	3.0	5.0	S
C _{iss}			2500	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		300	pF
C _{rss}			95	pF
t _{d(on)}) Basistina Caritabia a Timos		30	ns
ţ	Resistive Switching Times		55	ns
t _{d(off)}	$\begin{cases} V_{GS} = 15V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{DSS} \\ R_{G} = 4.7\Omega \text{ (External)} \end{cases}$		110	ns
ţ)			65	ns
$Q_{g(on)}$			155	nC
Q_{gs}	$V_{GS} = 20V, V_{DS} = 0.5 \bullet V_{DSS}, I_{D} = 0.5 \bullet I_{DSS}$		35	nC
Q _{gd}			55	nC
R _{thJC}				0.31 °C/W
R _{thCS}			0.21	°C/W

Safe-Operating-Area Specification

Symbol	Test Conditions Characteristic Value			alues
		Min.	Тур.	Max.
SOA	$V_{DS} = 800V, I_{D} = 0.25A, T_{C} = 60^{\circ}C$	200		W

TO-247 (IXTH) Outline Q s ь2 — e Terminals: 1 - Gate 2 - Drain 3 - Source Dim. Millimeter Inches Min. Max. Min. Max. 4.7 5.3 .185 .209 2.2 2.54 087 102 2.2 A 2.6 .059 .098

b

b,

b,

С

D

Ε

е

L

ØP

Q

R

1.0

1.65

2.87

20.80

15.75

5.20

19.81

3.55

5.89

4.32

6.15 BSC

1.4

2.13

3.12

21.46

16.26

5.72

4.50

3.65

6.40

5.49

20.32

.8

040

.065

.113

.016

.819

.610

0.205

.780

.140

0.232

.170

242 BSC

055

.084

.123

.031

.845

.640

0.225

.800

.177

.144

0.252

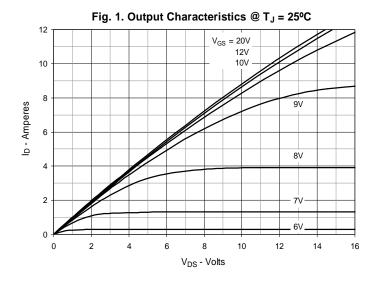
.216

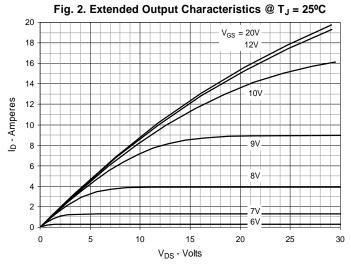
Source-Drain Diode

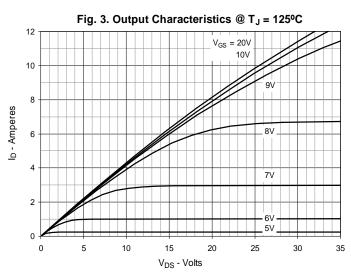
Symbol (T _J = 25°C, U		Characteristic Values Min. Typ. Max.			
I _s	$V_{GS} = 0V$			12	Α
I _{sm}	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			48	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1			1.5	V
t _{rr}	$I_{_{\rm F}} = I_{_{\rm S}}, -\text{di/dt} = 100 \text{A/}\mu\text{s}, V_{_{\rm R}} = 100 \text{V}, V_{_{\rm GS}} = 0 \text{V}$		1000		ns

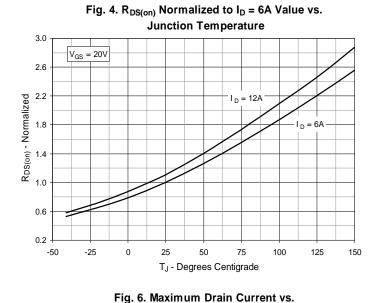
Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

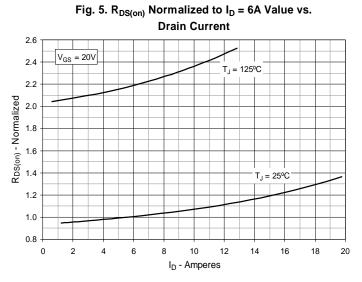


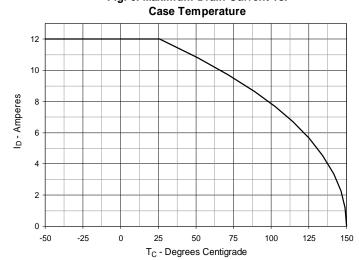






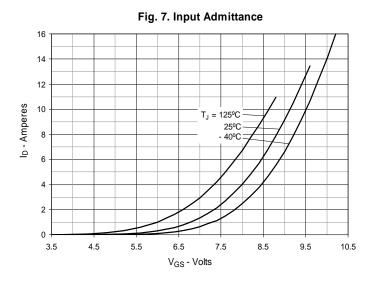


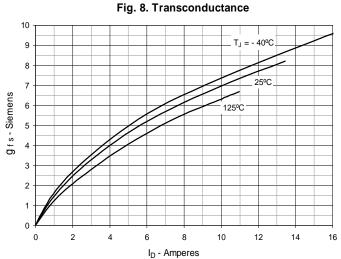


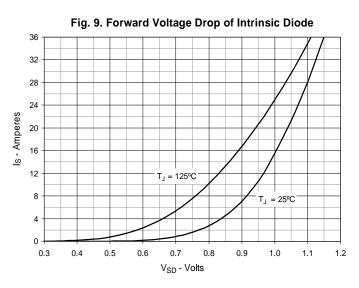


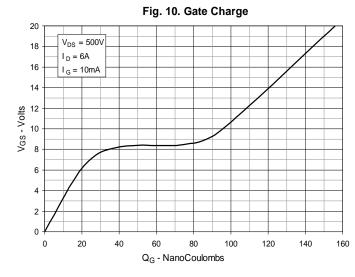
© 2010 IXYS CORPORATION, All Rights Reserved

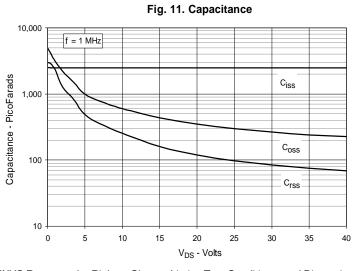


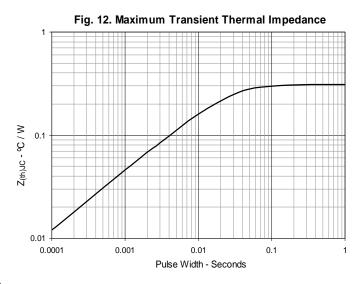












IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.



Fig. 13. Forward-Bias Safe Operating Area

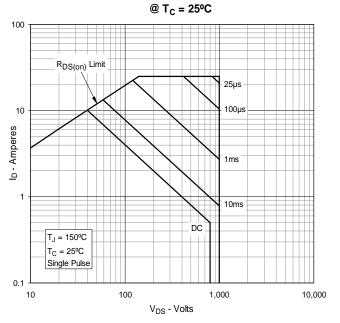


Fig. 14. Forward-Bias Safe Operating Area $@T_C = 60^{\circ}C$

